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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild guestions@onsemi.com.

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April 2016

FDD8444_F085

N-Channel PowerTrench® MOSFET 40V, 50A, 5.2mΩ

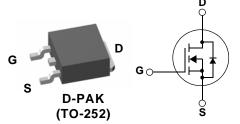
Features

- Typ $R_{DS(on)} = 4m\Omega$ at $V_{GS} = 10V$, $I_D = 50A$
- Typ $Q_{g(10)}$ = 89nC at V_{GS} = 10V, I_D = 50A
- Low Miller Charge
- Low Qrr Body Diode
- UIS Capability (Single Pulse/ Repetitive Pulse)
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Transmission
- Distributed Power Architecture and VRMs
- Primary Switch for 12V Systems





For current package drawing, please refer to the Fairchild website at http://www.fairchildsemi.com/package-drawings/TO/ TO252A03.pdf.

MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{DSS}	Drain to Source Voltage	40	V
V_{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (V _{GS} = 10V)	50	۸
ID	Pulsed	Figure 4	Α
E _{AS}	Single Pulse Avalanche Energy (Note 1)	535	mJ
D	Power Dissipation	153	W
P_D	Derate above 25°C	1.02	W/°C
T _J , T _{STG}	Operating and Storage Temperature	-55 to +175	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case	0.98	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient, 1in ² copper pad area	52	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8444	FDD8444_F085	TO-252AA	13"	12mm	2500 units

- 1: Starting T_J = 25°C, L = 0.67mH, I_{AS} = 40A 2: A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced in Aug 2014.

Units

Max

Тур

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Parameter

Off Characteristics								
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS}$	= 0V	40	-	-	V	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32V,$		-	-	1	^	
		$V_{GS} = 0V$	$T_A = 150^{\circ}C$	=	-	250	μΑ	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA	

Test Conditions

Min

On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2	2.5	4	V
r _{DS(on)}		$I_D = 50A, V_{GS} = 10V$	-	4	5.2	mΩ
	Drain to Source On Resistance	$I_D = 50A, V_{GS} = 10V$ $T_J = 175^{\circ}C$	-	7.2	9.4	

Dynamic Characteristics

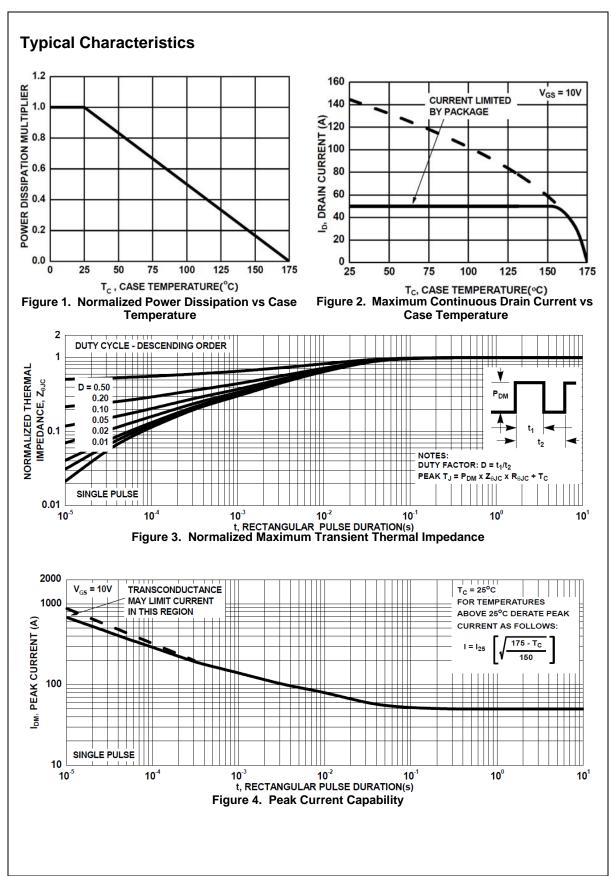
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	6195	-	pF
C _{oss}	Output Capacitance			-	585	-	pF
C _{rss}	Reverse Transfer Capacitance			ı	332		pF
R_G	Gate Resistance	f = 1MHz		-	1.9	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V		-	89	116	nC
Q _{g(TH)}	Threshold Gate Charge	$V_{GS} = 0 \text{ to } 2V$ $V_{DD} = 20V$		11	-	nC	
Q _{gs}	Gate to Source Gate Charge	I _D = 50A		-	23	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			1	20	1	nC

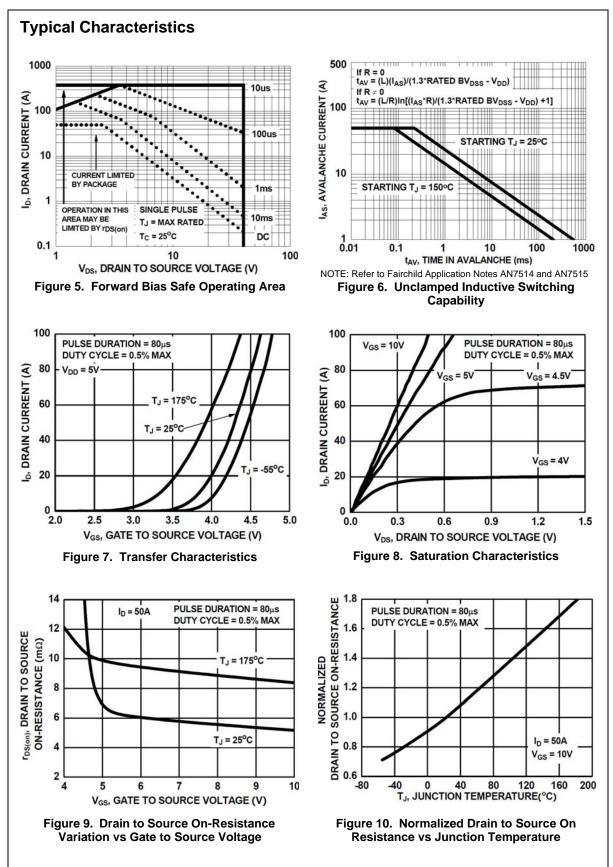
Switching Characteristics

t _{on}	Turn-On Time	$V_{DD} = 20V, I_{D} = 50A$ $V_{GS} = 10V, R_{GS} = 2\Omega$	-	-	135	ns
t _{d(on)}	Turn-On Delay Time		-	12	-	ns
t _r	Rise Time		-	78	-	ns
t _{d(off)}	Turn-Off Delay Time		-	48	-	ns
t _f	Fall Time		-	15	-	ns
t _{off}	Turn-Off Time		-	-	95	ns

Drain-Source Diode Characteristics

V _{SD}	Source to Drain Diode Voltage	I _{SD} = 50A	-	-	1.25	\/	
		I _{SD} = 25A	-	-	1.0	\ \	
t _{rr}	Reverse Recovery Time	$I_{SD} = 50A$, $dI_{SD}/dt = 100A/\mu s$		39	51	ns	
Q _{rr}	Reverse Recovery Charge		1	45	59	nC	





Typical Characteristics

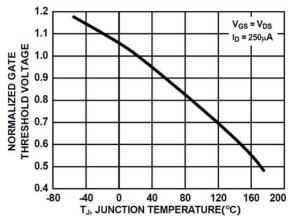


Figure 11. Normalized Gate Threshold Voltage vs
Junction Temperature

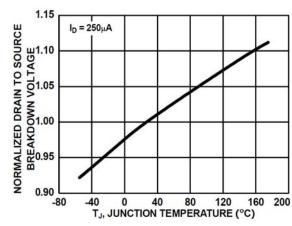


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

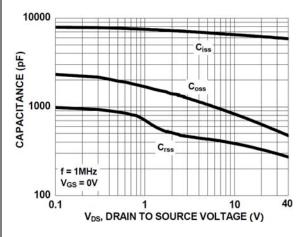


Figure 13. Capacitance vs Drain to Source Voltage

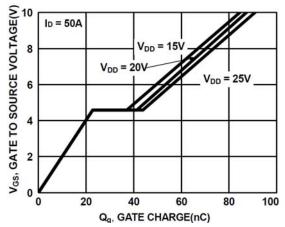


Figure 14. Gate Charge vs Gate to Source Voltage



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